



Product Change Notification

Change Notification #: 118260-00
Change Title: Power Options,
PCN 118260-00, Product Design,
Power Supply FCXX2100CRPS Cold
Redundancy improvement
Date of Publication: May 13, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 27, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

- Improve the Cold Redundancy feature (CR) Wake-up to reduce the current peaks that could trigger the PSU protection mechanism.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
FCXX2100CRPS	999D4L	K45917-001	K45917-002

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
May 13, 2021	00	Originally Published PCN



Product Change Notification

118260-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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